SIEMENS

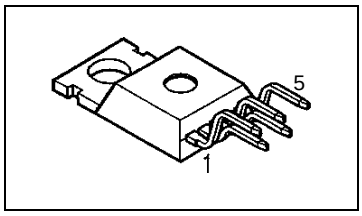
Smart Highside Power Switch

Features

- Load dump and reverse battery protection[1)]
- Clamp of negative voltage at output
- Short-circuit protection
- Current limitation
- Thermal shutdown
- Diagnostic feedback
- Open load detection in OFF-state
- CMOS compatible input
- **E**lectro**s**tatic **d**ischarge (**ESD**) protection
- Loss of ground and loss of V_{bb} protection[2)]
- Overvoltage protection
- Undervoltage and overvoltage shutdown with auto-restart and hysteresis

Product Summary

$V_{Load\ dump}$	80	V
V_{bb}-V_{OUT} Avalanche Clamp	58	V
V_{bb} (operation)	4.5 ... 42	V
V_{bb} (reverse)	-32	V
R_{ON}	38	mΩ
$I_{L(SCp)}$	42	A
$I_{L(SCr)}$	33	A
$I_{L(ISO)}$	11	A

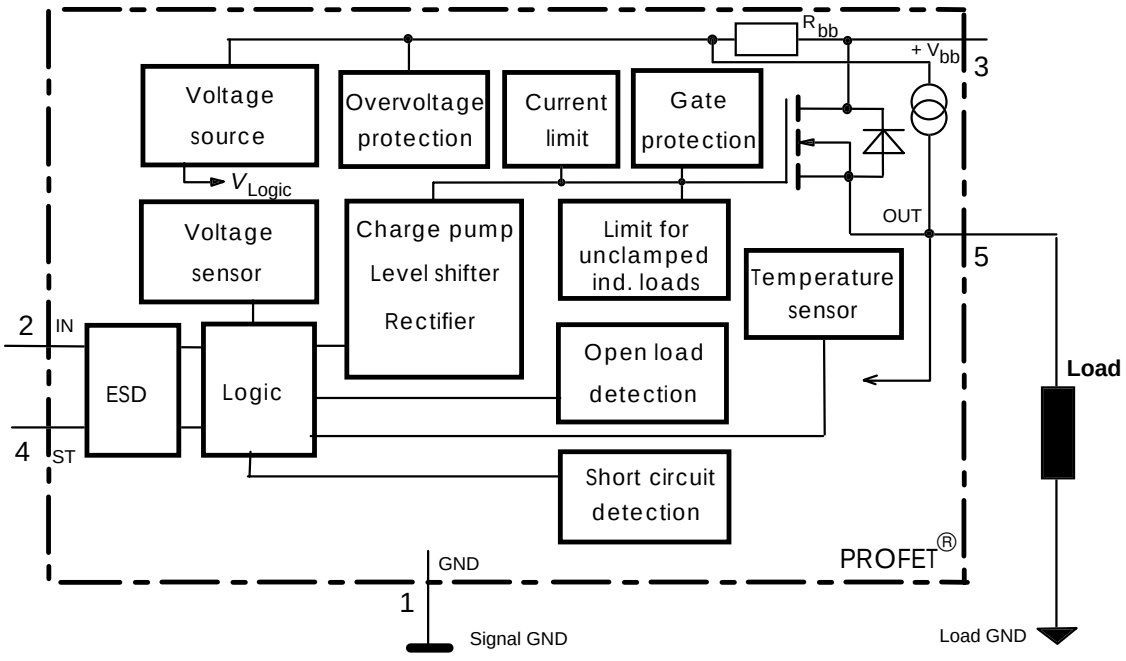


Application

- µC compatible power switch with diagnostic feedback for 12 V and 24 V DC grounded loads
- All types of resistive, inductive and capacitve loads
- Replaces electromechanical relays and discrete circuits

General Description

N channel vertical power FET with charge pump, ground referenced CMOS compatible input and diagnostic feedback, integrated in Smart SIPMOS® chip on chip technology. Fully protected by embedded protection functions.



1) No external components required, reverse load current limited by connected load.
2) Additional external diode required for charged inductive loads

Pin	Symbol		Function
1	GND	-	Logic ground
2	IN	I	Input, activates the power switch in case of logical high signal
3	Vbb	+	Positive power supply voltage, the tab is shorted to this pin
4	ST	S	Diagnostic feedback, low on failure
5	OUT (Load, L)	O	Output to the load

Maximum Ratings at T_j = 25 °C unless otherwise specified

Parameter	Symbol	Values	Unit
Supply voltage (overvoltage protection see page 3)	V_{bb}	63	V
Load dump protection $V_{LoadDump} = U_A + V_s$, U_A = 13.5 V R_I= 2 Ω, R_L= 1.1 Ω, t_d= 200 ms, IN= low or high	V_s[3)]	66.5	V
Load current (Short-circuit current, see page 4)	I_L	self-limited	A
Operating temperature range	T_j	-40 ...+150	°C
Storage temperature range	T_{stg}	-55 ...+150	
Power dissipation (DC)	P_{tot}	125	W
Inductive load switch-off energy dissipation, single pulse T_j=150 °C:	E_{AS}	1.7	J
Electrostatic discharge capability (ESD) (Human Body Model)	V_{ESD}	2.0	kV
Input voltage (DC)	V_{IN}	-0.5 ... +6	V
Current through input pin (DC)	I_{IN}	±5.0	mA
Current through status pin (DC) see internal circuit diagrams page 6...	I_{ST}	±5.0	

Thermal resistance chip - case:	R_{thJC}	≤ 1	K/W
junction - ambient (free air):	R_{thJA}	≤ 75	
SMD version, device on pcb[4)]:		≤ tbd	

3) V_S is setup without DUT connected to the generator per ISO 7637-1 and DIN 40839

4) Device on 50mm*50mm*1.5mm epoxy PCB FR4 with 6cm² (one layer, 70µm thick) copper area for V_{bb} connection. PCB is vertical without blown air.

Electrical Characteristics

Parameter and Conditions at T_j = 25 °C, V_{bb} = 12 V unless otherwise specified	Symbol	Values			Unit
		min	typ	max	
Load Switching Capabilities and Characteristics					
On-state resistance (pin 3 to 5)					
I_L = 2 A T_j=25 °C:	R_{ON}	--	30	38	mΩ
T_j=150 °C:			55	70	
Nominal load current (pin 3 to 5) ISO Proposal: V_{ON} = 0.5 V, T_C = 85 °C	$I_{L(ISO)}$	9	11	--	A
Output current (pin 5) while GND disconnected or GND pulled up, V_{IN}= 0, see diagram page 7, T_j =-40...+150°C	$I_{L(GNDhigh)}$	--	--	1	mA
Turn-on time to 90% V_{OUT}:	t_{on}	50	160	300	µs
Turn-off time to 10% V_{OUT}:	t_{off}	10	--	80	
R_L = 12 Ω, T_j =-40...+150°C					
Slew rate on 10 to 30% V_{OUT}, R_L = 12 Ω, T_j =-40...+150°C	dV/dt_{on}	0.4	--	2.5	V/µs
Slew rate off 70 to 40% V_{OUT}, R_L = 12 Ω, T_j =-40...+150°C	$-dV/dt_{off}$	1	--	5	V/µs
Operating Parameters					
Operating voltage [5] T_j =-40...+150°C:	$V_{bb(on)}$	4.5	--	42	V
Undervoltage shutdown T_j =-40...+150°C:	$V_{bb(under)}$	2.4	--	4.5	V
Undervoltage restart T_j =-40...+150°C:	$V_{bb(u\ rst)}$	--	--	4.5	V
Undervoltage restart of charge pump see diagram page 12 T_j =-40...+150°C:	$V_{bb(ucp)}$	--	6.5	7.5	V
Undervoltage hysteresis $\Delta V_{bb(under)} = V_{bb(u\ rst)} - V_{bb(under)}$	$\Delta V_{bb(under)}$	--	0.2	--	V
Overvoltage shutdown T_j =-40...+150°C:	$V_{bb(over)}$	42	--	52	V
Overvoltage restart T_j =-40...+150°C:	$V_{bb(o\ rst)}$	42	--	--	V
Overvoltage hysteresis T_j =-40...+150°C:	$\Delta V_{bb(over)}$	--	0.2	--	V
Overvoltage protection[6] T_j =-40°C:	$V_{bb(AZ)}$	60	--	--	V
I_{bb}=40 mA T_j =25...+150°C:		63	67		
Standby current (pin 3)	$I_{bb(off)}$				µA
V_{IN}=0, I_{ST}=0, T_j=-40...+25°C:		--	40	70	
T_j=150°C:		--	50	110	
Operating current (Pin 1)[7], V_{IN}=5 V	I_{GND}	--	1.1	--	mA

5) At supply voltage increase up to V_{bb}= 6.5 V typ without charge pump, $V_{OUT} \approx V_{bb}$ - 2 V

6) see also $V_{ON(CL)}$ in table of protection functions and circuit diagram page 7. Meassured without load.

7) Add I_{ST}, if I_{ST} > 0, add I_{IN}, if V_{IN}>5.5 V

Parameter and Conditions at T_j = 25 °C, V_{bb} = 12 V unless otherwise specified	Symbol	Values min	Values typ	Values max	Unit
Protection Functions					
Initial peak short circuit current limit (pin 3 to 5)[8], (max 400 µs if $V_{ON} > V_{ON(SC)}$)	$I_{L(SCp)}$				
T_j =-40°C:		--	--	72	A
T_j =25°C:		--	42	--	
T_j =+150°C:		22	--	--	
Repetitive short circuit current limit $T_j = T_{jt}$ (see timing diagrams, page 10)	$I_{L(SCr)}$	20	33	--	A
Short circuit shutdown delay after input pos. slope $V_{ON} > V_{ON(SC)}$, T_j =-40..+150°C: min value valid only, if input "low" time exceeds 30 µs	$t_{d(SC)}$	80	--	400	µs
Output clamp (inductive load switch off) at $V_{OUT} = V_{bb} - V_{ON(CL)}$, I_L= 30 mA	$V_{ON(CL)}$	--	58	--	V
Short circuit shutdown detection voltage (pin 3 to 5)	$V_{ON(SC)}$	--	8.3	--	V
Thermal overload trip temperature	T_{jt}	150	--	--	°C
Thermal hysteresis	ΔT_{jt}	--	10	--	K
Inductive load switch-off energy dissipation[9], $T_{j\,Start}$ = 150 °C, single pulse V_{bb} = 12 V:	E_{AS} E_{Load12}	--	--	1.7 1.3	J
V_{bb} = 24 V:	E_{Load24}			1.0	
Reverse battery (pin 3 to 1) [10]	$-V_{bb}$	--	--	32	V
Integrated resistor in V_{bb} line	R_{bb}	--	120	--	Ω
Diagnostic Characteristics					
Open load detection current	$I_{L(off)}$	10	30	60	µA
Open load detection voltage T_j=-40..150°C:	$V_{OUT(OL)}$	2	3	4	V

8) Short circuit current limit for max. duration of 400 µs, prior to shutdown (see $t_{d(SC)}$ page 4)

9) While demagnetizing load inductance, dissipated energy in PROFET is $E_{AS} = \int V_{ON(CL)} * i_L(t)\,dt$, approx. $E_{AS} = {}^1/_2 * L * I_L^2 * \left(\frac{V_{ON(CL)}}{V_{ON(CL)} - V_{bb}}\right)$, see diagram page 8

10) Reverse load current (through intrinsic drain-source diode) is normally limited by the connected load. Reverse current I_{GND} of ≈ 0.3 A at V_{bb}= -32 V through the logic heats up the device. Time allowed under these condition is dependent on the size of the heatsink. Reverse I_{GND} can be reduced by an additional external GND-resistor (150 Ω). Input and Status currents have to be limited (see max. ratings page 2 and circuit page 7).

Parameter and Conditions at T_j = 25 °C, V_{bb} = 12 V unless otherwise specified	Symbol	Values			Unit
		min	typ	max	
Input and Status Feedback[11)]					
Input turn-on threshold voltage ⎍ T_j =-40..+150°C:	$V_{IN(T+)}$	1.5	--	2.4	V
Input turn-off threshold voltage ⎎ T_j =-40..+150°C:	$V_{IN(T-)}$	1.0	--	--	V
Input threshold hysteresis	$\Delta V_{IN(T)}$	--	0.5	--	V
Off state input current (pin 2) V_{IN} = 0.4 V:	$I_{IN(off)}$	1	--	30	µA
On state input current (pin 2) V_{IN} = 3.5 V:	$I_{IN(on)}$	10	25	50	µA
Delay time for status with open load after Input neg. slope (see diagram page 12)	$t_{d(ST\ OL3)}$	40	--	300	µs
Status invalid after positive input slope (short circuit) T_j=-40 ... +150°C:	$t_{d(ST\ SC)}$	80	200	400	µs
Status output (CMOS) T_j =-40...+150°C, I_{ST}= - 50 µA:	$V_{ST(high)}$[12)]	4.4	5.1	6.5	V
T_j =-40...+150°C, I_{ST} = +1.6 mA:	$V_{ST(low)}$	--	--	0.4	
Max. status current for current source (out):	$-I_{ST}$	--	--	0.25	mA
valid status output, current sink (in) :	$+I_{ST}$[13)]	--	--	1.6	
T_j =-40...+150°C					

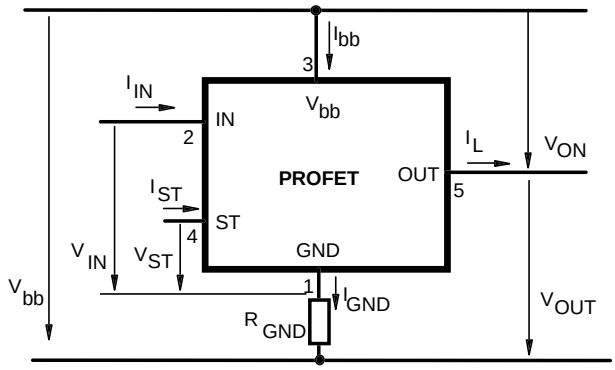
11) If a ground resistor R_{GND} is used, add the voltage drop across this resistor.
12) $V_{St\ high} \approx V_{bb}$ during undervoltage shutdown
13) No current sink capability during undervoltage shutdown

Truth Table

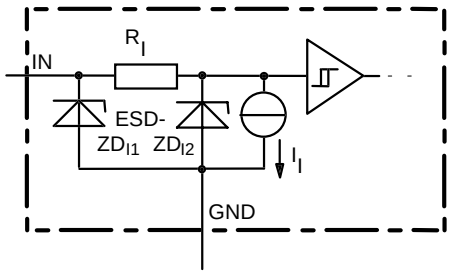
	Input-level	Output level	Status 432 D2	Status 432 E2/F2	Status **432 I2**
Normal operation	**L** **H**	**L** **H**	H H	H H	**H** **H**
Open load	**L** **H**	[14] **H**	H L	H L	**L** **H**
Short circuit to GND	**L** **H**	**L** **L**	H L	H L	**H** **L**
Short circuit to V_{bb}	**L** **H**	**H** **H**	H H (L[15])	H H (L[15])	**L** **H**
Overtem-perature	**L** **H**	**L** **L**	L L	L L	**L** **L**
Under-voltage	**L** **H**	**L** **L**	L[16] L[16]	H H	**L[16]** **L[16]**
Overvoltage	**L** **H**	**L** **L**	L L	H H	**L** **L**

L = "Low" Level
H = "High" Level

Terms

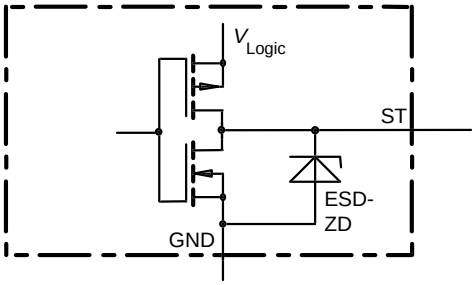


Input circuit (ESD protection)



ZD_{I1} 6.1 V typ., ESD zener diodes are not designed for continuous current

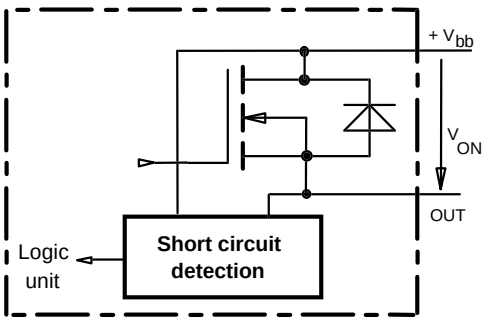
Status output



Zener diode: 6.1 V typ., max 5 mA, V_{Logic} 5 V typ, ESD zener diodes are not designed for continuous current

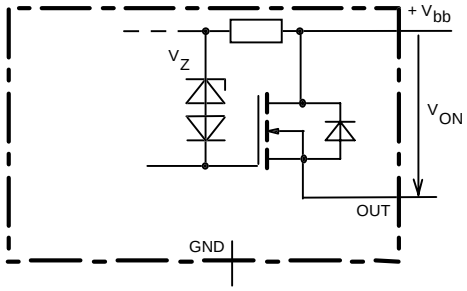
Short Circuit detection

Fault Condition: V_{ON} > 8.3 V typ.; IN high



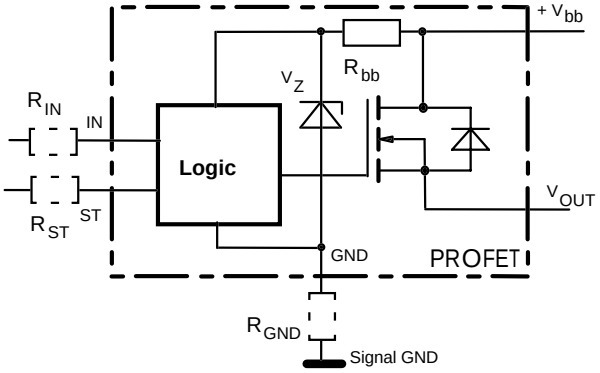
14) Power Transistor off, high impedance
15) Low resistance short V_{bb} to output may be detected by no-load-detection
16) No current sink capability during undervoltage shutdown

Inductive and overvoltage output clamp



V_{ON} clamped to 58 V typ.

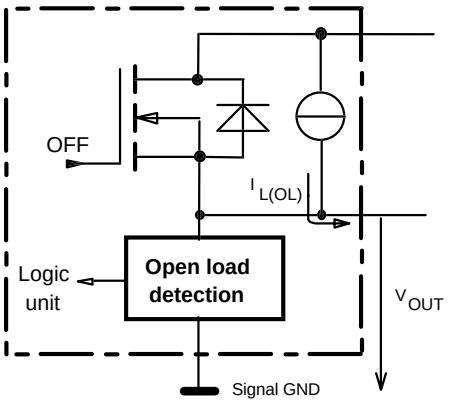
Overvolt. and reverse batt. protection



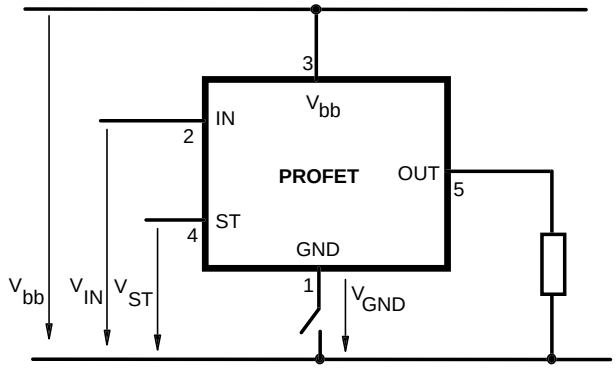
R_{bb} = 120 Ω typ., V_Z +R_{bb}*40 mA = 67 V typ., add R_{GND}, R_{IN}, R_{ST} for extended protection

Open-load detection

OFF-state diagnostic condition: V_{OUT} > 3 V typ.; IN low

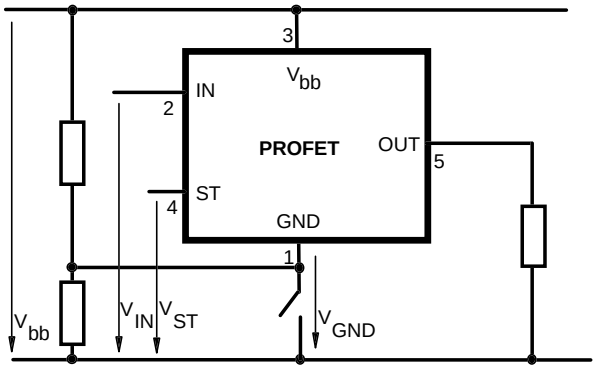


GND disconnect



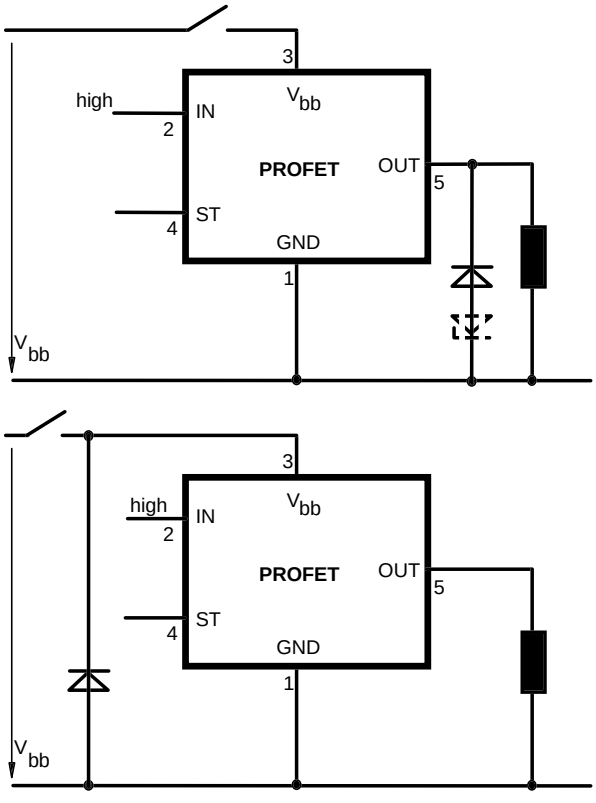
Any kind of load. In case of Input=high is $V_{OUT} \approx V_{IN} - V_{IN(T+)}$.
Due to V_{GND} >0, no V_{ST} = low signal available.

GND disconnect with GND pull up

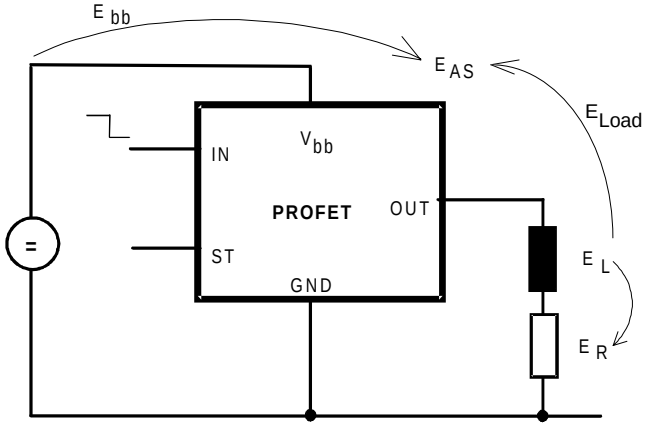


Any kind of load. If V_{GND} > V_{IN} - $V_{IN(T+)}$ device stays off
Due to V_{GND} >0, no V_{ST} = low signal available.

V_{bb} disconnect with charged inductive load



Inductive Load switch-off energy dissipation



Energy dissipated in PROFET $E_{AS} = E_{bb} + E_L - E_R$.

$E_{Load} < E_L$, $E_L = {}^1/_2 * L * I_L^2$

Options Overview

all versions: High-side switch, Input protection, ESD protection, load dump and reverse battery protection , protection against loss of ground

Type BTS	432D2	432E2	432F2	**432I2**
Logic version	D	E	F	**I**
Overtemperature protection				
T_j >150 °C, latch function[17)18)]	X		X	**X**
T_j >150 °C, with auto-restart on cooling		X		
Short-circuit to GND protection				
switches off when V_{ON}>8.3 V typ.[17)] (when first turned on after approx. 200 µs)	X	X	X	**X**
Open load detection				
in OFF-state with sensing current 30 µA typ.				**X**
in ON-state with sensing voltage drop across power transistor	X	X	X	
Undervoltage shutdown with auto restart	X	X	X	**X**
Overvoltage shutdown with auto restart	X	X	X	**X**
Status feedback for				
overtemperature	X	X	X	**X**
short circuit to GND	X	X	X	**X**
short to V_{bb}	-[19)]	-[**19**)]	-[19)]	**X**
open load	X	X	X	**X**
undervoltage	X	-	-	**X**
overvoltage	X	-	-	**X**
Status output type				
CMOS	X			**X**
Open drain		X	X	
Output negative voltage transient limit (fast inductive load switch off)				
to V_{bb} - $V_{ON(CL)}$	X	X	X	**X**
Load current limit				
high level (can handle loads with high inrush currents)	X	X		
medium level				**X**
low level (better protection of application)			X	

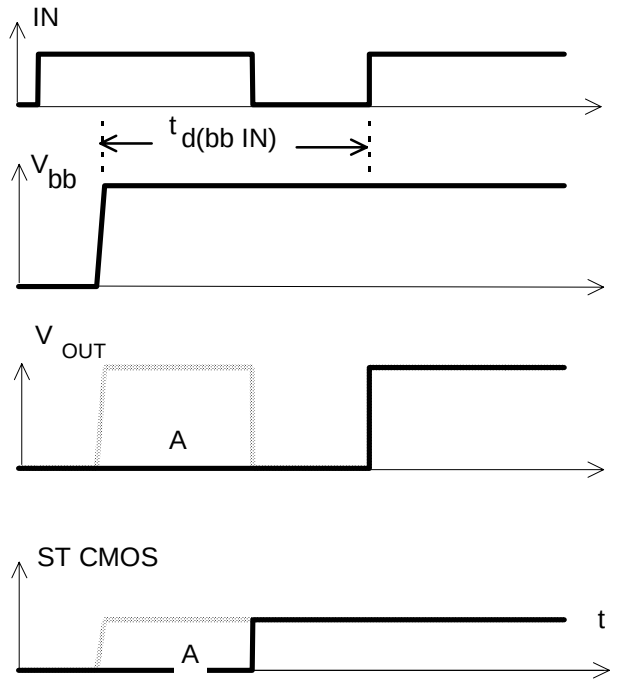
17) Latch except when V_{bb} - V_{OUT} < $V_{ON(SC)}$ after shutdown. In most cases V_{OUT} = 0 V after shutdown ($V_{OUT} \neq$ 0 V only if forced externally). So the device remains latched unless $V_{bb} < V_{ON(SC)}$ (see page 4). No latch between turn on and $t_{d(SC)}$.

18) With latch function. Reseted by a) Input low, b) Undervoltage, c) Overvoltage

19) Low resistance short V_{bb} to output may be detected by no-load-detection

Timing diagrams

Figure 1a: V_{bb} turn on:



in case of too early V_{IN}=high the device may not turn on (curve A)
$t_{d(bb\ IN)}$ approx. 150 µs

Figure 2a: Switching a lamp,

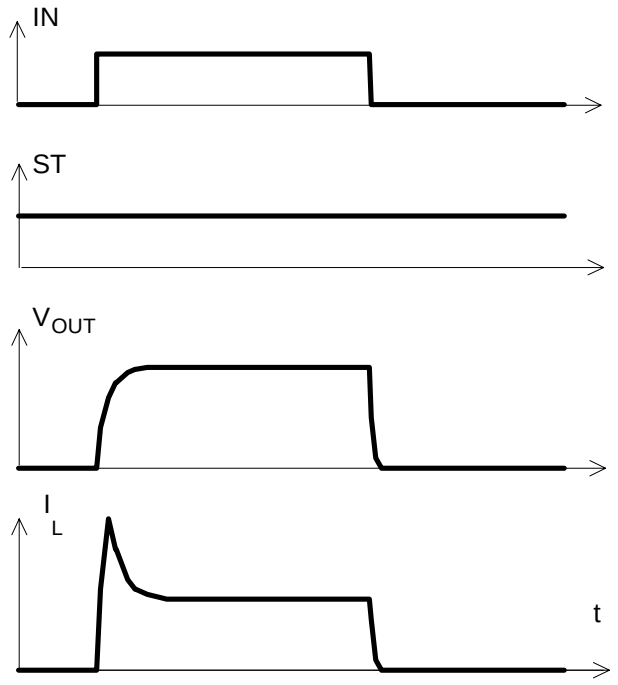


Figure 2b: Switching an inductive load

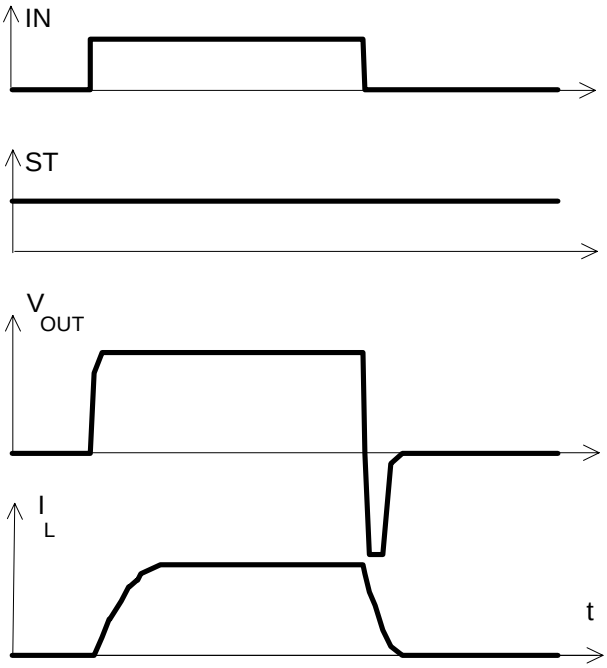
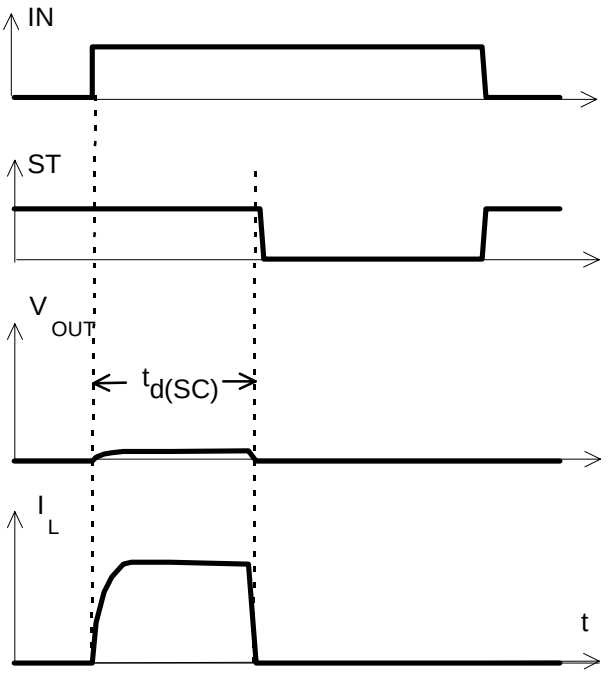
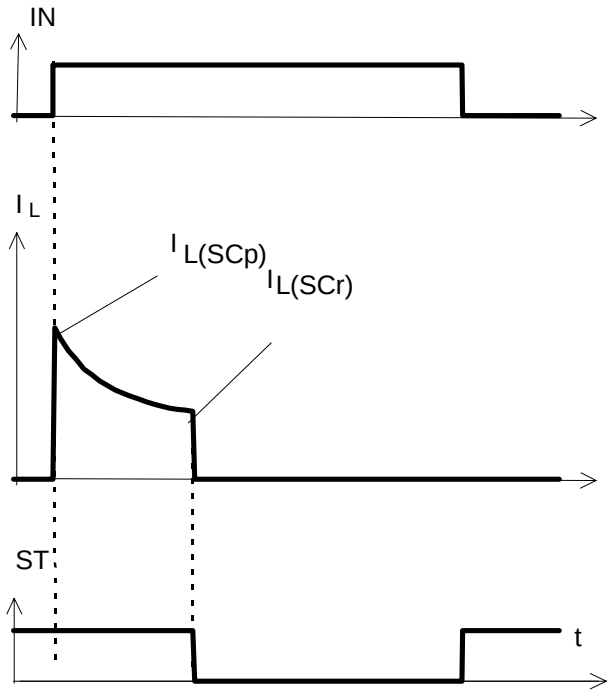


Figure 3a: Turn on into short circuit,



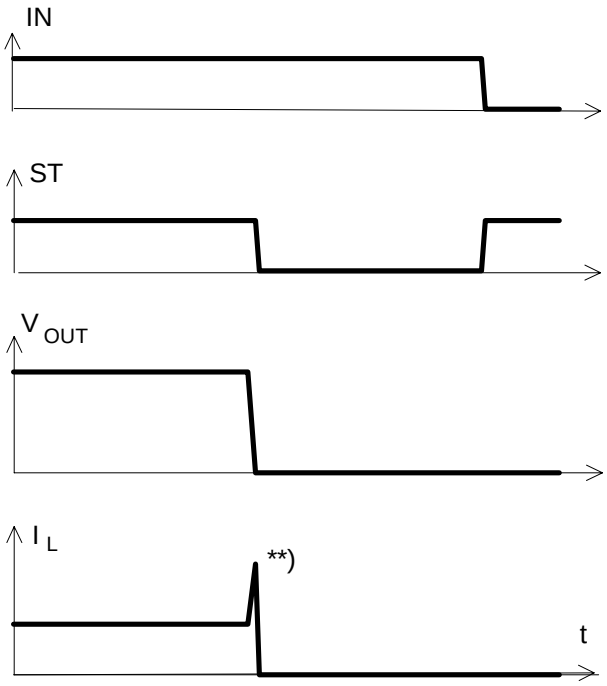
$t_{d(SC)}$ approx. 200µs if V_{bb} - V_{OUT} > 8.3 V typ.

Figure 3b: Turn on into overload,



Heating up may require several milliseconds , V_{bb} - V_{OUT} < 8.3 V typ.

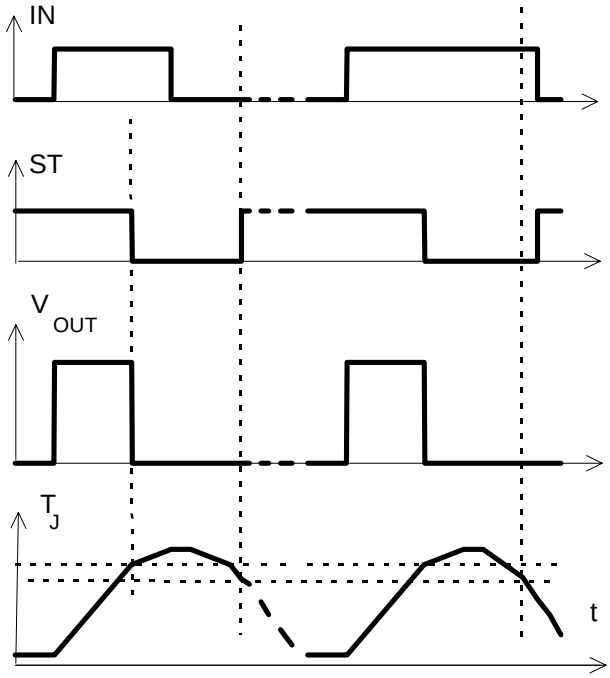
Figure 3c: Short circuit while on:



**) current peak approx. 20 µs

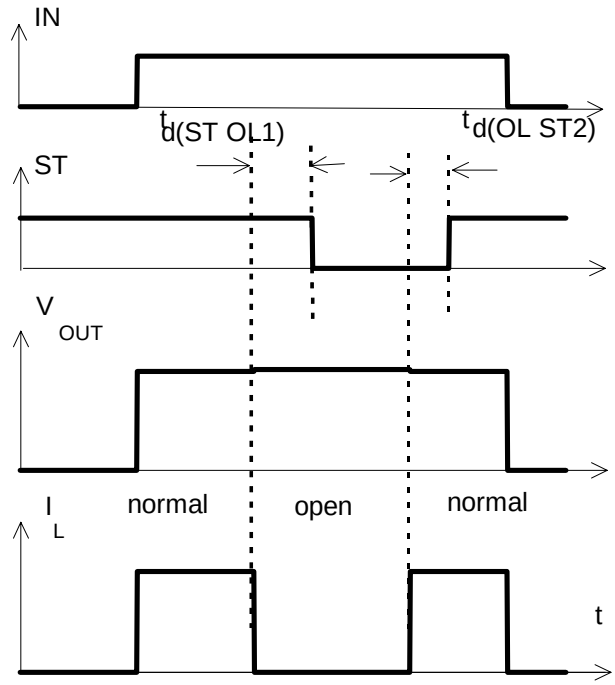
Figure 4a: Overtemperature,

Reset if (IN=low) and (T_j<T_{jt})



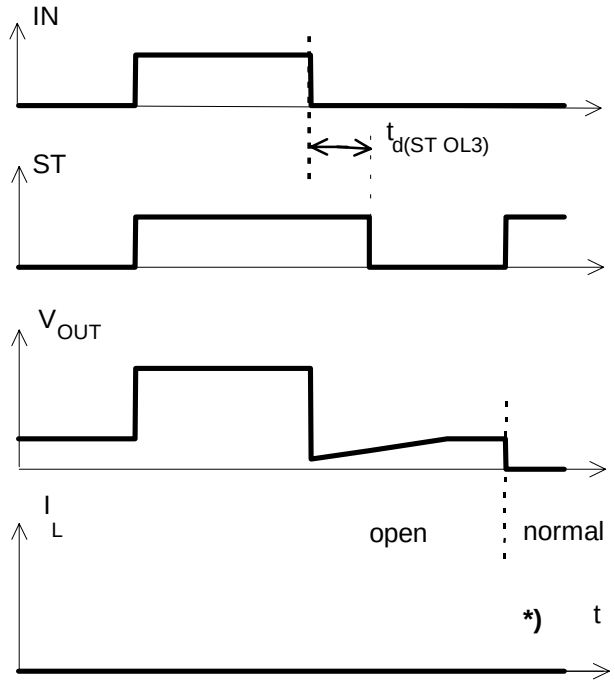
*) ST goes high , when V_{IN}=low **and** T_j<T_{jt}

Figure 5a: Open load: detection in ON-state, open load occurs in on-state



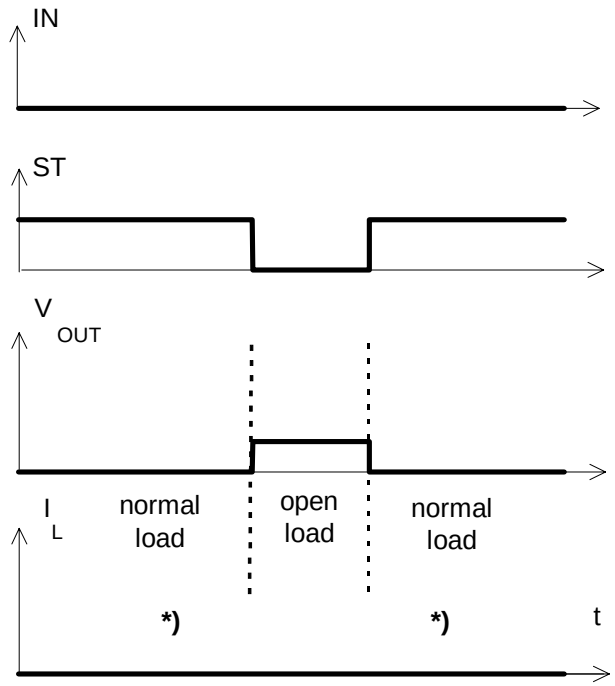
$t_{d(ST\ OL1)}$ = tbd µs typ., $t_{d(ST\ OL2)}$ = tbd µs typ

Figure 5b: Open load: detection in OFF-state, turn on/off to open load



in case of external capacity $t_{d(ST,OL3)}$ may be higher due to high impedance *) I_L = 30 µA typ

Figure 5c: Open load: detection in OFF-state, open load occurs in off-state



*) I_L = 30 µA typ

Figure 6a: Undervoltage:

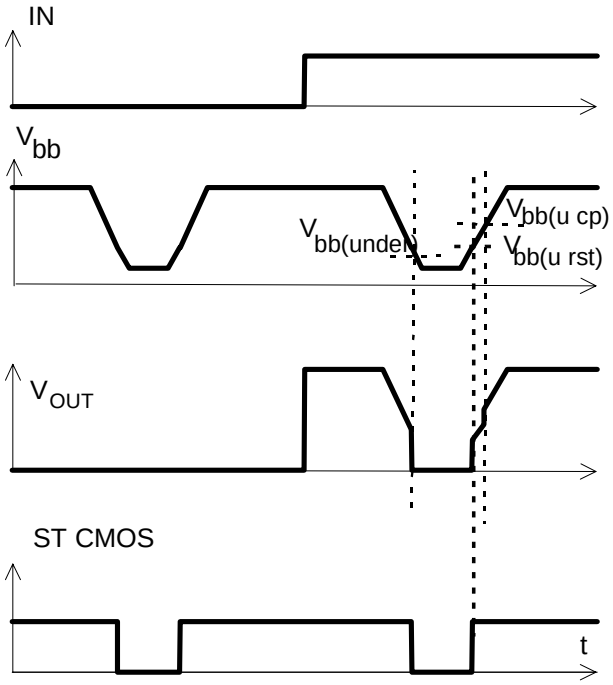
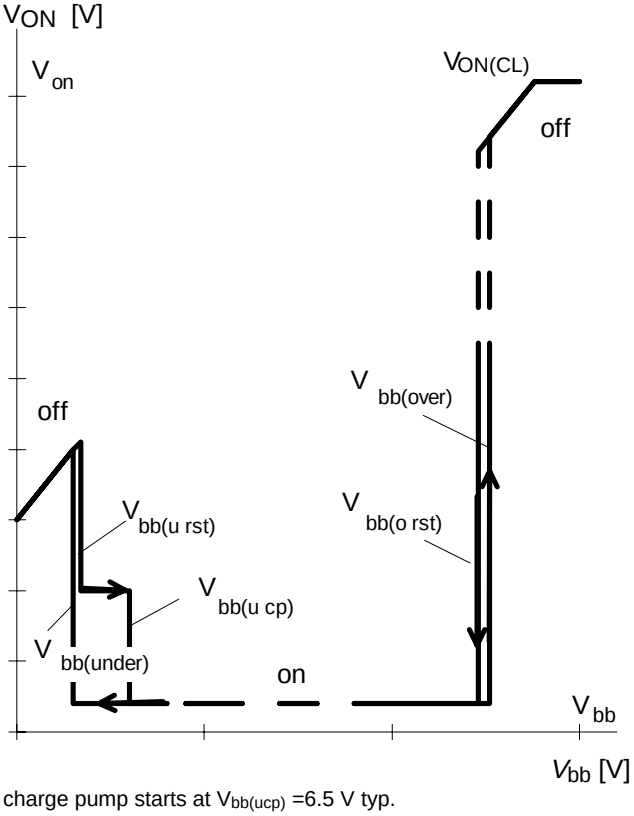
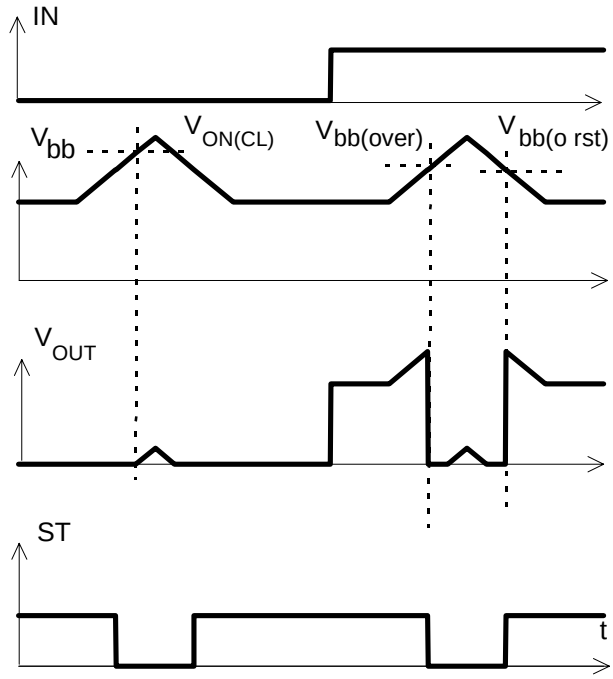


Figure 6b: Undervoltage restart of charge pump



charge pump starts at $V_{bb(ucp)}$ =6.5 V typ.

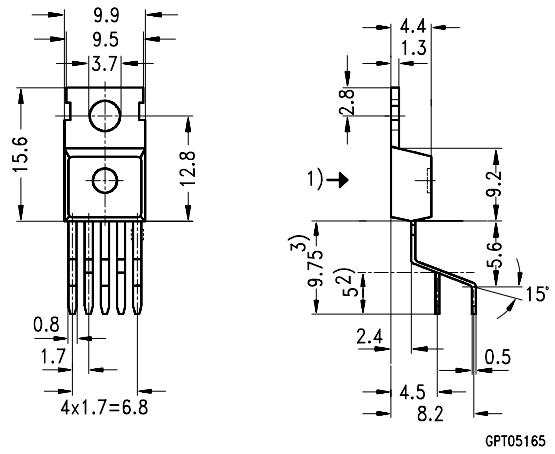
Figure 7a: Overvoltage:



Package and Ordering Code

All dimensions in mm

Standard TO-220AB/5	Ordering code
BTS 432 I2	Q67060-S6204-A2



1) shear and punch direction no burrs this surface
2) min. length by tinning
3) max. 11 mm allowable by tinning

SMD TO-220AB/5, Opt. E3122 Ordering code		
BTS 432 I2 E3122A	T&R:	Q67060-S6204-A3